Declaration and Power of Attorney Under Patent Cooperation Treaty 35 USC §371(c)(4)

As a below named inventor, I hereby declare that:

my residence, post office address and citizenship are as stated below next to my name; that

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to my	I acknowledge my dur pplication in accordance ventor's certificate on this international application	with lit	ie 37, Code of ion has been fil	Federal Regulations. led in any country fo	, §1.56(a), and that no preign to the United S	application for patent
	Japanese Patent					
hereb substi	The priority of the aby claimed under 35 USO tution and revocation to	J 119.	I nereby appoi	nt the following as	my attorneys of reco	rd with full names of
	W. Parkhurst, Reg. No					
	ALL CORRESPOND CHURST & WENDEL.	ENCE I	IN CONNECT	TON WITH THIS	APPLICATION SHO	III D DE CENT TO.
2805,	TELEPHONE (703) 7	39-0220	•	, , , , , , , , , , , , , , , , , , ,		, YIRGINIA 22514-
made be true are pu	I hereby declare that I herein of my own knowe; and further that these snishable by fine or impossible that the statements must be statements in the statements of the statement	iledge ar statemen risonmer	e true and that ts were made w it or both, und	all statements made with knowledge that we for Section 1001 of T	on information and willful false statements Title 18 of the United	belief are believed to s and the like so made States Code and that
3.	Full Name of Sole	00	TZ =	-	• •	
	or First Inventor	Given	Name	Middle Initial	MORIM	
*4.	Inventor's Signature	<i>F</i>	Kenji	Morimoto	Family	name
	Date of Signature	₽	March	11,		2002
6.	Residence 866-3, 0	hmachi	Month Saijo-shi	Day - Ehime 793-003	Tanan (TD)	Year
	City			or Province	Countr	<u></u>
7.	Citizenship Japanes	e				,
8.	Post Office address (Insert complete mailin address, including cou	ıg			LECTRONICS INDUS	

*IF THERE IS MORE THAN ONE INVENTOR USE PAGE 2 AND PLACE AN "X" HERE .

PAGE 2 OF U.S.A. DECLARATION FORM (Discard this page in a sole inventor application)

Second Joint Inventor (if any)	Hiroshi Given Name	Middle Initial	OCHI Family Name	
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iventor's Signature	Hiroshi		UCH	
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nui John myomoi (it any)	Given Name	Middle Initial	Family Name	
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Inventor's Signature				
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address, including country)	e on line 4 exactly as it appears in			

^{**}This form may be executed only when attached to the first page of the Declaration and Power of Attorney form and the specification (including claims) of the application to which it pertains.